

IGBT – Power, Single N-Channel, Field Stop VII (FS7), SCR, TO247-4L 1200 V, 1.66 V, 60 A

AFGH4L60T120RW-STD

Description

Using the novel field stop 7th generation IGBT technology in TO247 4-lead package, this device offers good performance with low on state voltage and low switching losses for both hard and soft switching topologies in automotive applications.

Features

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature – $T_J = 175^\circ\text{C}$
- Short Circuit Rated and Low Saturation Voltage
- Fast Switching and Tightened Parameter Distribution
- AEC-Q101 Qualified, PPAP Available Upon Request
- This Device is Pb-Free, Halogen Free/BFR Free and is RoHS Compliant

Applications

- Automotive E-compressor / Automotive EV PTC Heater / OBC

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

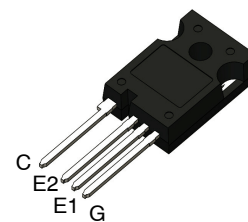
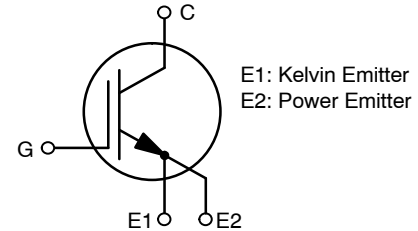
Parameter	Symbol	Value	Unit	
Collector-to-Emitter Voltage	V_{CE}	1200	V	
Gate-to-Emitter Voltage	V_{GE}	± 20		
Transient Gate-to-Emitter Voltage		± 30		
Collector Current	I_C	$T_C = 25^\circ\text{C}$ (Note 1)	73	A
		$T_C = 100^\circ\text{C}$	60	
Power Dissipation	P_D	$T_C = 25^\circ\text{C}$	289	W
		$T_C = 100^\circ\text{C}$	134	
Pulsed Collector Current	I_{CM}	180	A	
Short Circuit Withstand Time $V_{GE} = 15\text{ V}, V_{CC} = 800\text{ V}, T_C = 150^\circ\text{C}$	T_{SC}	6	μs	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to +175	$^\circ\text{C}$	
Lead Temperature for Soldering Purposes	T_L	260		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Value limit by bond wire
2. Repetitive rating: Pulse width limited by max. junction temperature

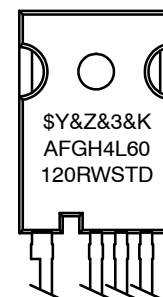
BV_{CES}	$V_{CE(sat)}$ TYP	I_C MAX
1200 V	1.66 V	60 A

PIN CONNECTIONS



TO-247-4LD
CASE 340CJ

MARKING DIAGRAM



\$Y = onsemi Logo
&Z = Assembly Plant Code
&3 = 3-Digit Date Code
&K = 2-Digit Lot Traceability Code
AFGH4L60120RWSTD = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping
AFGH4L60T120RW-STD	TO-247-4L (Pb-Free)	30 Units / Tube

AFGH4L60T120RW-STD

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case for IGBT	$R_{\theta JC}$	0.26	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	40	

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-to-Emitter Breakdown Voltage	BV_{CES}	$V_{GE} = 0\text{ V}, I_C = 1\text{ mA}$	1200	-	-	V
Collector-to-Emitter Cut-Off Current	I_{CES}	$V_{GE} = 0\text{ V}, V_{CE} = V_{CES}$	-	-	40	μA
Gate-to-Emitter Leakage Current	I_{GES}	$V_{GE} = \pm 20\text{ V}, V_{CE} = 0\text{ V}$	-	-	± 400	nA

ON CHARACTERISTICS

Gate-to-Emitter Threshold Voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 60\text{ mA}$	5.1	6	6.9	V
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE} = 15\text{ V}, I_C = 60\text{ A}, T_J = 25^\circ\text{C}$	-	1.66	1.99	V
		$V_{GE} = 15\text{ V}, I_C = 60\text{ A}, T_J = 175^\circ\text{C}$	-	2.14	-	

DYNAMIC CHARACTERISTICS

Input Capacitance	C_{IES}	$V_{CE} = 30\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	-	5330	-	pF
Output Capacitance	C_{OES}		-	114	-	
Reverse Transfer Capacitance	C_{RES}		-	23	-	
Total Gate Charge	Q_G	$V_{CE} = 600\text{ V}, V_{GE} = 15\text{ V}, I_C = 60\text{ A}$	-	174	-	nC
Gate-to-Emitter Charge	Q_{GE}		-	52	-	
Gate-to-Collector Charge	Q_{GC}		-	73.6	-	

SWITCHING CHARACTERISTICS, INDUCTIVE LOAD (Note: Si Diode Applied)

Turn-On Delay Time	$t_{d(on)}$	$V_{CE} = 600\text{ V}, V_{GE} = 15\text{ V},$ $I_C = 30\text{ A}, R_G = 6\ \Omega,$ $T_J = 25^\circ\text{C}$	-	62	-	ns
Rise Time	t_r		-	26	-	
Turn-Off Delay Time	$t_{d(off)}$		-	305	-	
Fall Time	t_f		-	207	-	
Turn-On Switching Loss	E_{on}	$V_{CE} = 600\text{ V}, V_{GE} = 15\text{ V},$ $I_C = 60\text{ A}, R_G = 6\ \Omega,$ $T_J = 25^\circ\text{C}$	-	1.48	-	mJ
Turn-Off Switching Loss	E_{off}		-	2.32	-	
Total Switching Loss	E_{ts}		-	3.8	-	
Turn-On Delay Time	$t_{d(on)}$		-	68	-	ns
Rise Time	t_r		-	9	-	
Turn-Off Delay Time	$t_{d(off)}$		-	264	-	
Fall Time	t_f		-	203	-	
Turn-On Switching Loss	E_{on}		-	3.03	-	mJ
Turn-Off Switching Loss	E_{off}		-	3.98	-	
Total Switching Loss	E_{ts}		-	7	-	

AFGH4L60T120RW-STD

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
SWITCHING CHARACTERISTICS, INDUCTIVE LOAD (Note: Si Diode Applied)						
Turn-On Delay Time	$t_{d(on)}$	$V_{CE} = 600\text{ V}, V_{GE} = 15\text{ V},$ $I_C = 30\text{ A}, R_G = 6\ \Omega,$ $T_J = 175^\circ\text{C}$	-	59	-	ns
Rise Time	t_r		-	34	-	
Turn-Off Delay Time	$t_{d(off)}$		-	347	-	
Fall Time	t_f		-	349	-	
Turn-On Switching Loss	E_{on}		-	2.68	-	mJ
Turn-Off Switching Loss	E_{off}		-	3.03	-	
Total Switching Loss	E_{ts}		-	5.7	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{CE} = 600\text{ V}, V_{GE} = 15\text{ V},$ $I_C = 60\text{ A}, R_G = 6\ \Omega,$ $T_J = 175^\circ\text{C}$	-	67	-	ns
Rise Time	t_r		-	52	-	
Turn-Off Delay Time	$t_{d(off)}$		-	313	-	
Fall Time	t_f		-	355	-	
Turn-On Switching Loss	E_{on}		-	5.61	-	mJ
Turn-Off Switching Loss	E_{off}		-	5.67	-	
Total Switching Loss	E_{ts}		-	11.28	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AFGH4L60T120RW-STD

TYPICAL CHARACTERISTICS

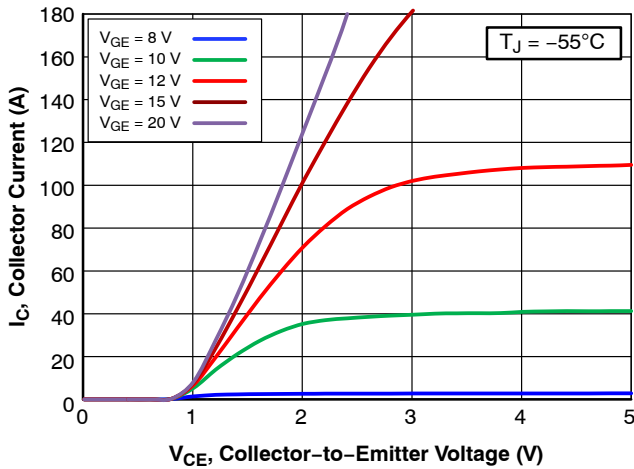


Figure 1. Typical Output Characteristics

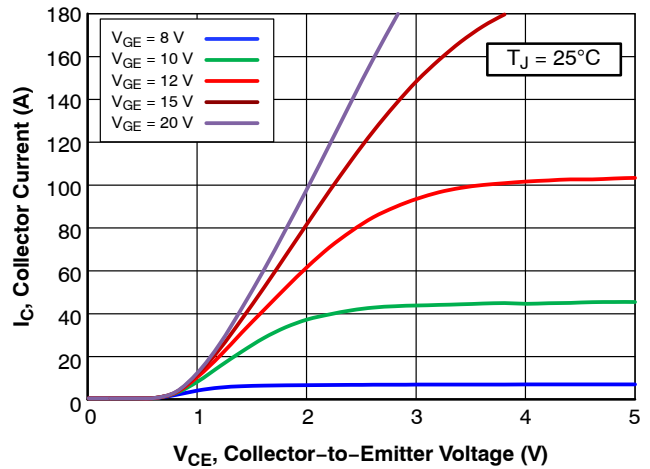


Figure 2. Typical Output Characteristics

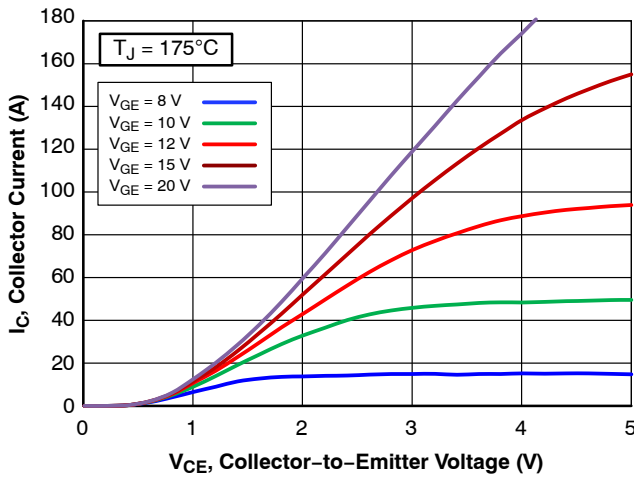


Figure 3. Typical Output Characteristics

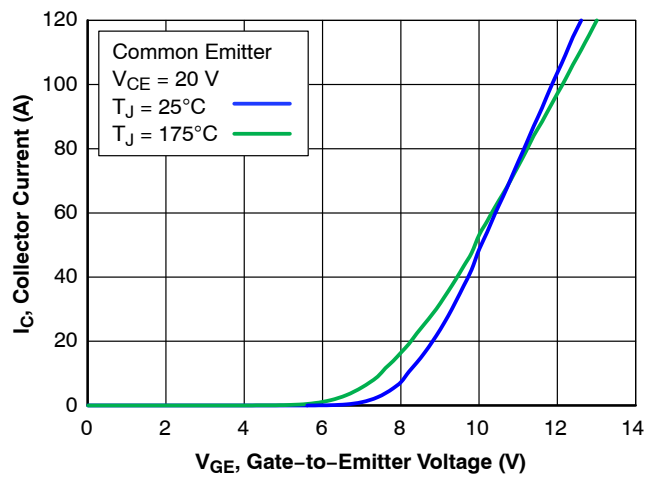


Figure 4. Transfer Characteristics

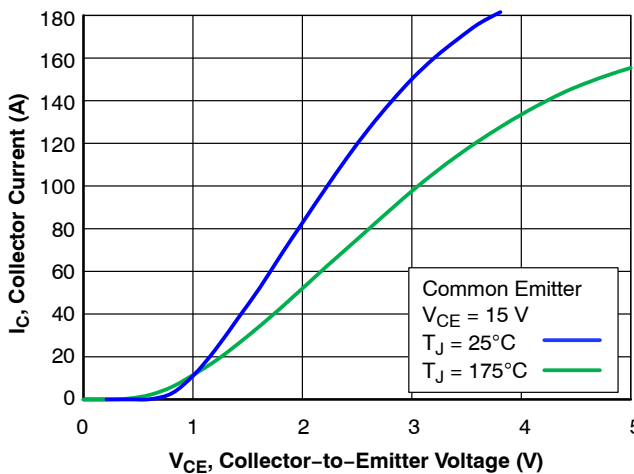


Figure 5. Saturation Voltage Characteristics

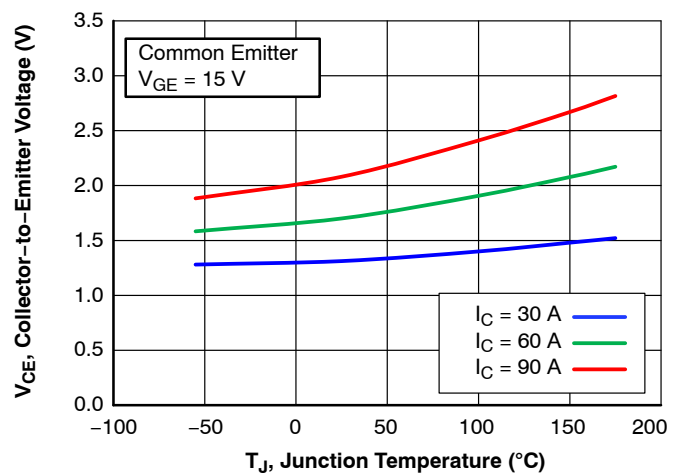


Figure 6. Saturation Voltage vs. Junction Temperature

AFGH4L60T120RW-STD

TYPICAL CHARACTERISTICS

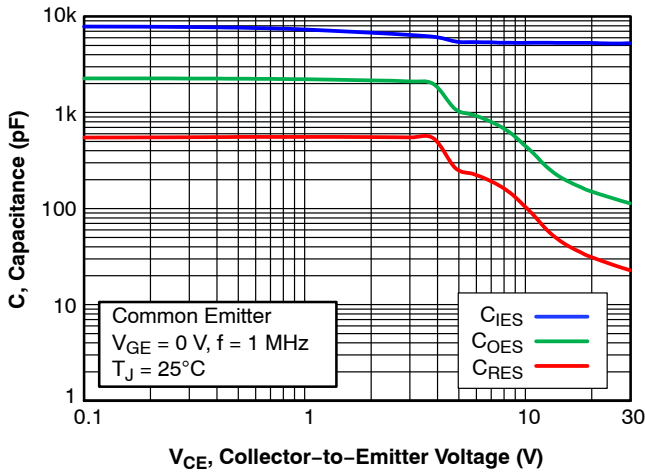


Figure 7. Capacitance Characteristics

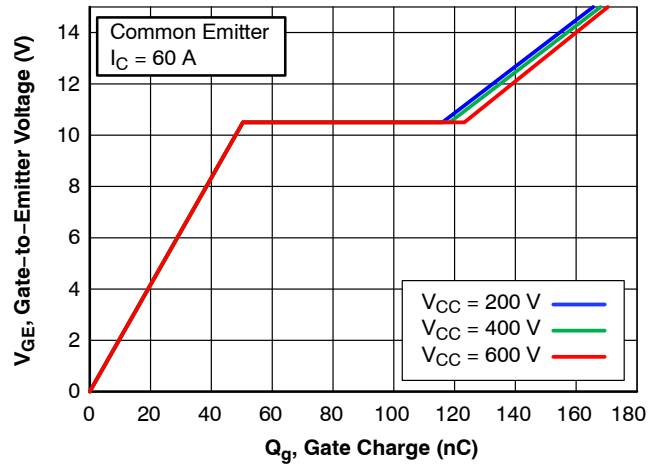


Figure 8. Gate Charge Characteristics

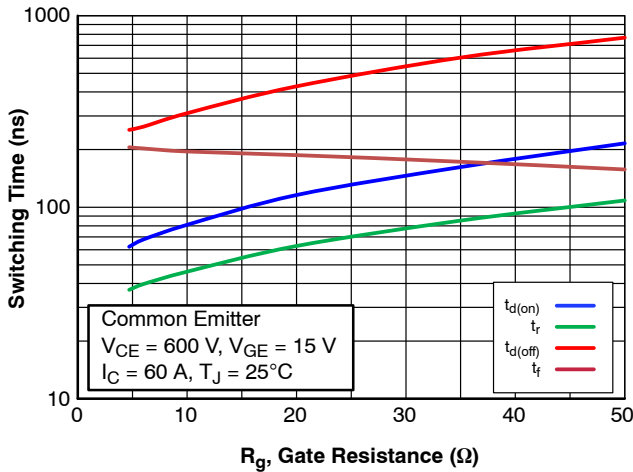


Figure 9. Switching Time vs. Gate Resistance

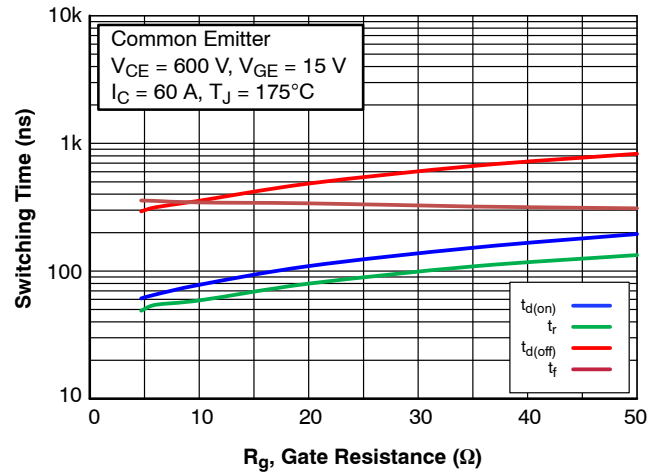


Figure 10. Switching Time vs. Gate Resistance

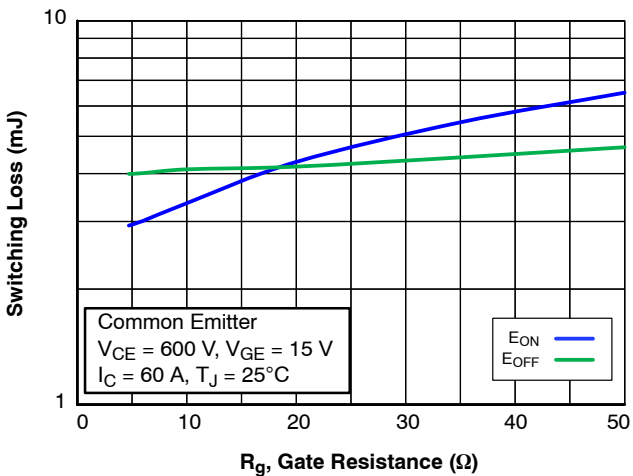


Figure 11. Switching Loss vs. Gate Resistance

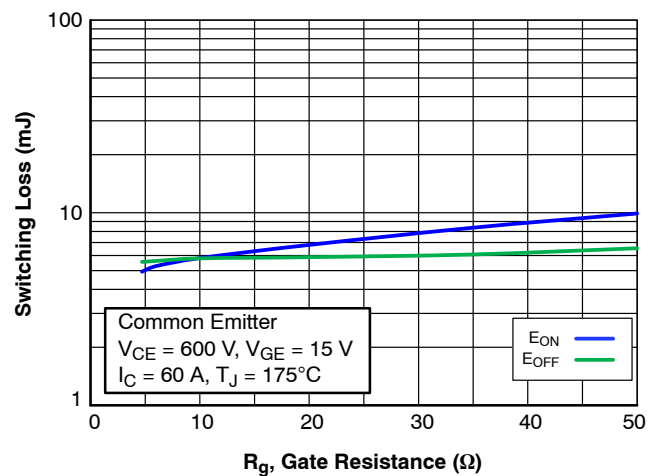


Figure 12. Switching Loss vs. Gate Resistance

AFGH4L60T120RW-STD

TYPICAL CHARACTERISTICS

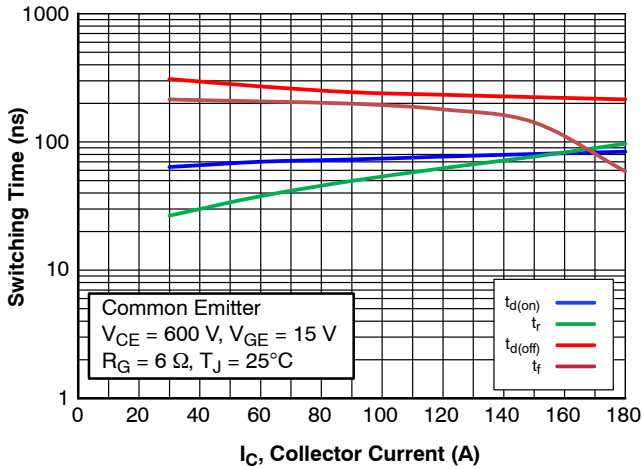


Figure 13. Switching Time vs. Collector Current

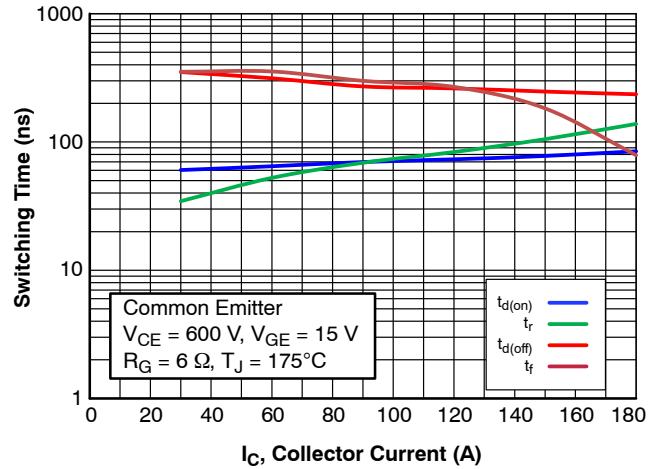


Figure 14. Switching Time vs. Collector Current

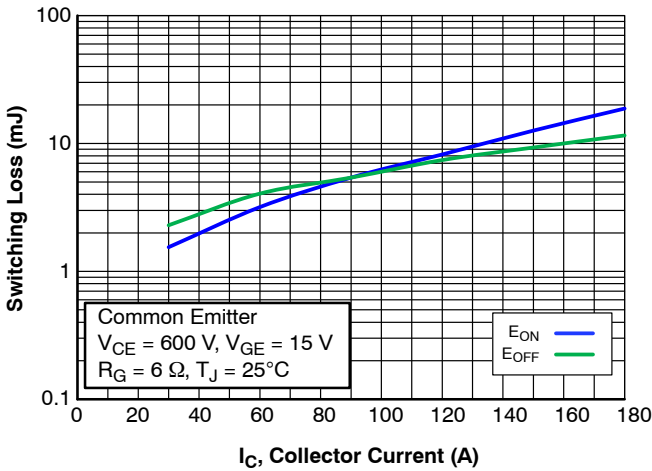


Figure 15. Switching Loss vs. Collector Current

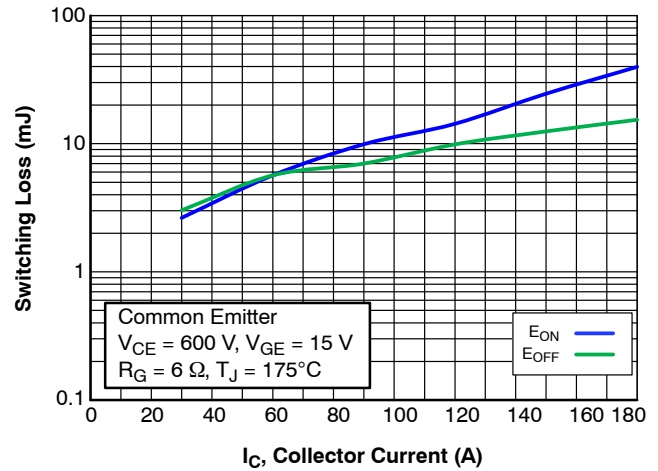


Figure 16. Switching Loss vs. Collector Current

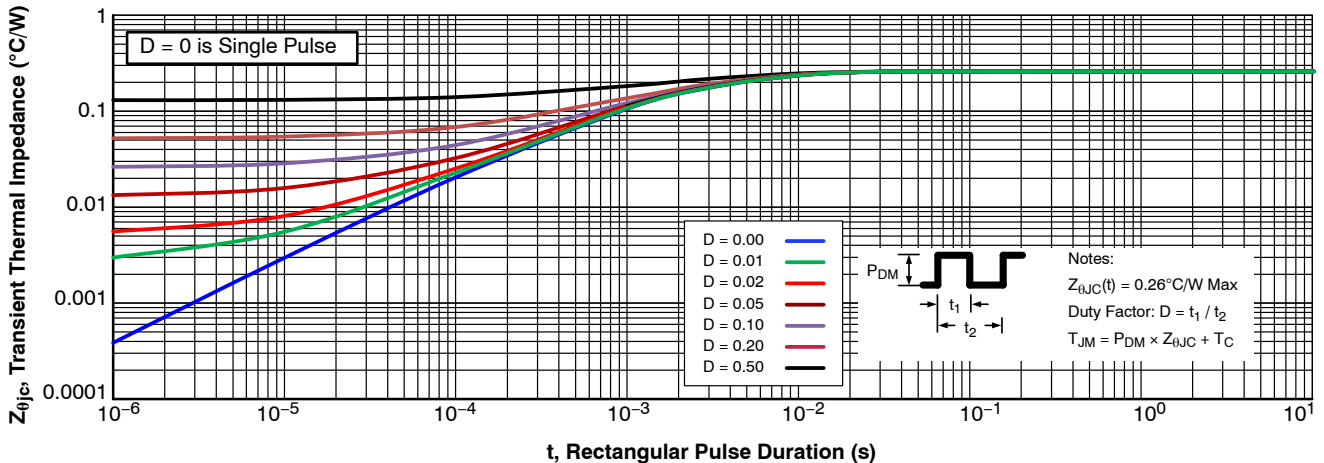
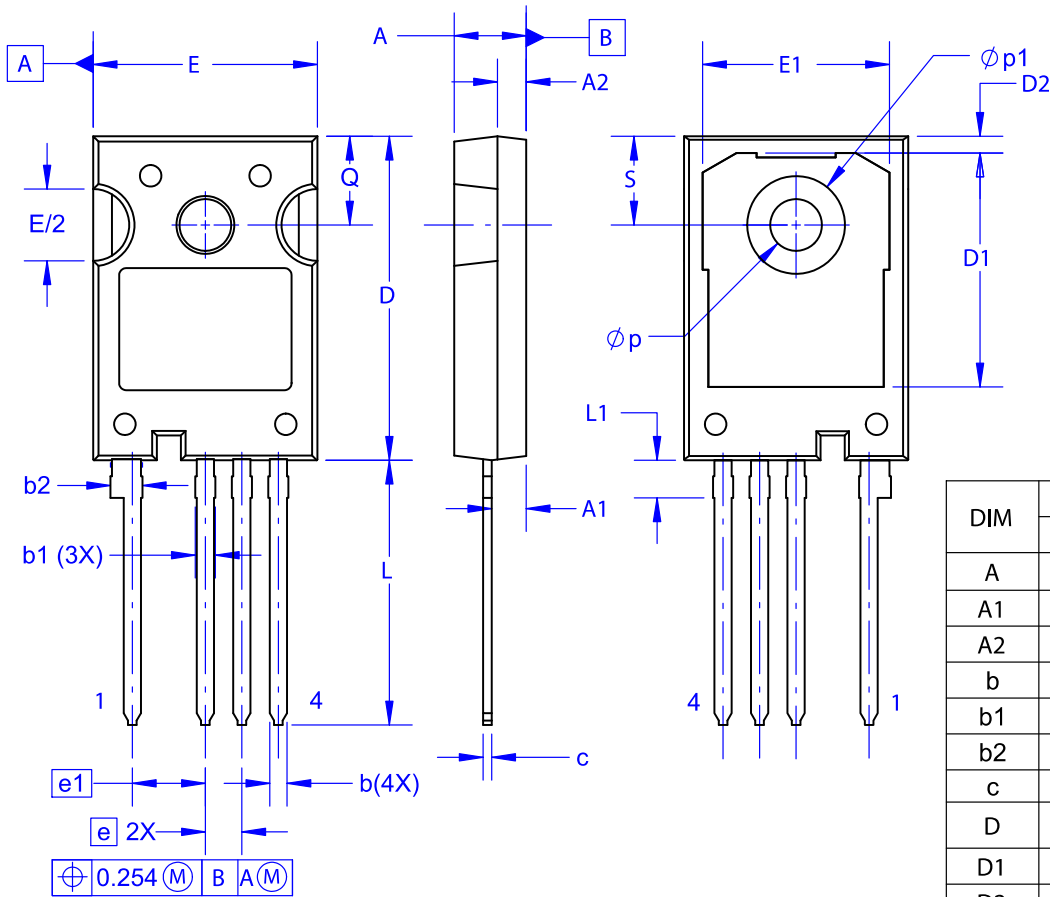


Figure 17. Transient Thermal Impedance of IGBT

AFGH4L60T120RW-STD

PACKAGE DIMENSIONS

TO-247-4LD
CASE 340CJ
ISSUE A



DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.10	2.40	2.70
A2	1.80	2.00	2.20
b	1.07	1.20	1.33
b1	1.20	1.40	1.60
b2	2.02	2.22	2.42
c	0.50	0.60	0.70
D	22.34	22.54	22.74
D1	16.00	16.25	16.50
D2	0.97	1.17	1.37
e	2.54 BSC		
e1	5.08 BSC		
E	15.40	15.60	15.80
E1	12.80	13.00	13.20
E/2	4.80	5.00	5.20
L	18.22	18.42	18.62
L1	2.42	2.62	2.82
p	3.40	3.60	3.80
p1	6.60	6.80	7.00
Q	5.97	6.17	6.37
S	5.97	6.17	6.37

NOTES:

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- B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
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